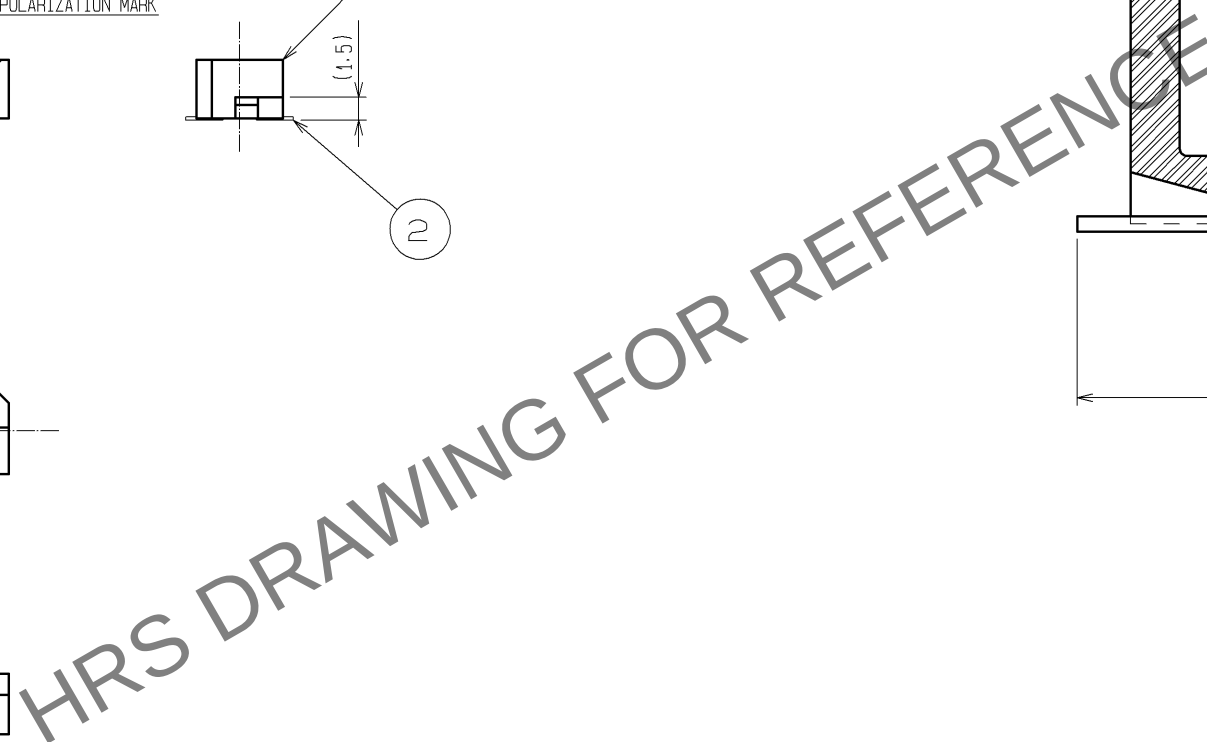
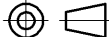


RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)
(METAL MASK THICKNESS:t=0.15)



- NOTE
- | | |
|---|--|
| 1 | HS MARK SHALL BE OPTIONAL. |
| 2 | LEAD CO-PLANARITY SHALL BE 0.1mm MAX. |
| 3 | FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES. |
| 4 | THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE. |

1	PPS	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1μm min.				
					LEAD AREA:TIN-PLATING 1μm min.				
					UNDER PLATING:NICKEL 2μm min.				
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		08. 06. 23	DRAWING NO. EDC3-071317-25				
		CHECED : HT. YAMAGUCHI		08. 06. 20	PART NO. FX6A-20S-0. 8SV(71)				
		DESIGNED : KN. SHIBUYA		08. 06. 20	CODE NO. CL576-0301-7-71				
		DRAWN : TH. SANO		08. 06. 19					
									